EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

Chip LED with Bi-Color (Multi-Color)

19-223/G6S2C-A01/2T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- RoHS refer to SMD B TYPE SGS report.

Descriptions

- The 19-223 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Chip		E	Long Colon	
Type	Material	Emitted Color	Lens Color	
G6	AlGaInP	Brilliant Yellow Green	W. Cl	
S2	AlGaInP	Brilliant Oange	Water Clear	



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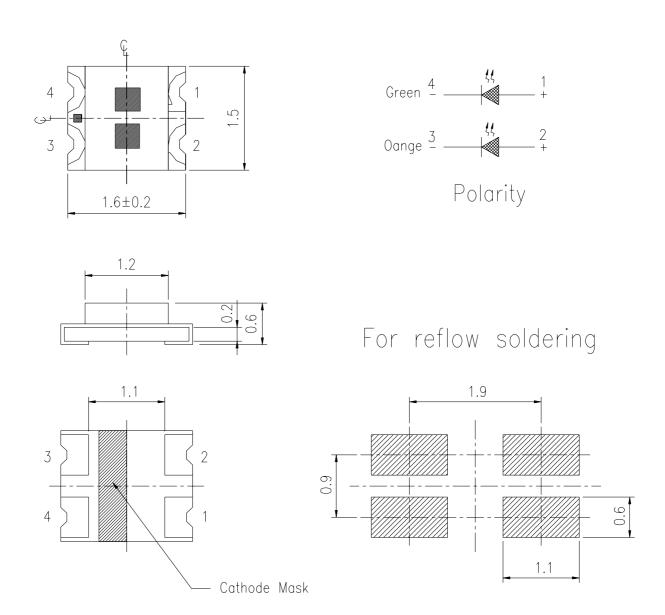
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Prepared date: 25-May-2005

Rev. 4

Page: 1 of 13

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:DSE-192-042

http://www.everlight.com

Rev. 4

Page: 2 of 13

Prepared date: 25-May-2005 Prepared by: Jeff Tsai



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	60	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv G6	28.5 112.0		45.0 140.0	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λ p G6 S2		575 611		nm	I _F =20mA
Dominant Wavelength	λd G6 S2	568.5 602.0		574.5 608.0	nm	ir—20IIIA
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	VF		2.0	2.4	V	
Reverse Current	Ir			10	μ A	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 4 Page: 3 of 13

Device No:DSE-192-042 Prepared date: 25-May-2005 Prepared by: Jeff Tsai



G6

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
N	28.5	45.0	mcd	I _F =20mA

S2

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
R1	112	140	mcd	I _F =20mA

Note:

The luminous intensity data did not including $\pm 10\%$ testing tolerance.

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Device No:DSE-192-042 Prepared date: 25-May-2005

Rev. 4

Page: 4 of 13

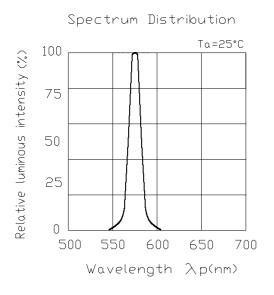
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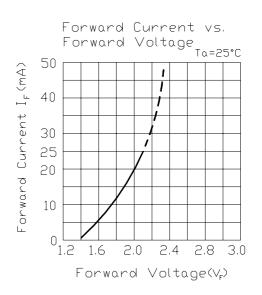
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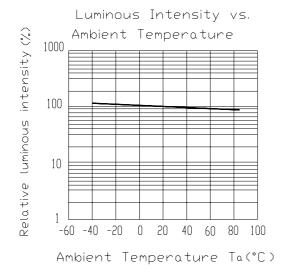


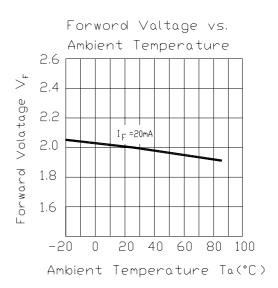
Typical Electro-Optical Characteristics Curves

G6









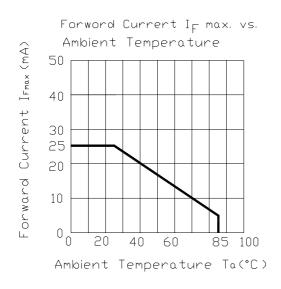
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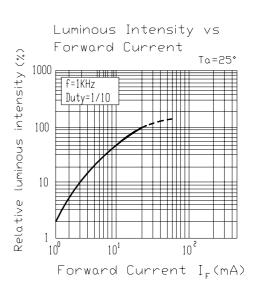
Device No:DSE-192-042

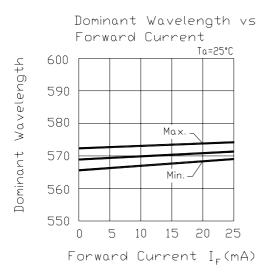


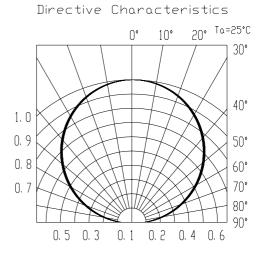
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Everlight Electronics Co., Ltd. Device No:DSE-192-042 http://www.everlight.com Prepared date: 25-May-2005

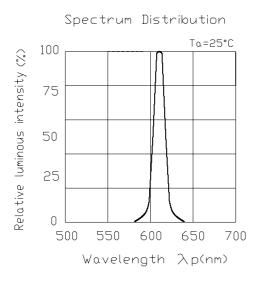
Rev. 4

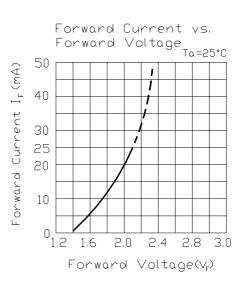
Page: 6 of 13

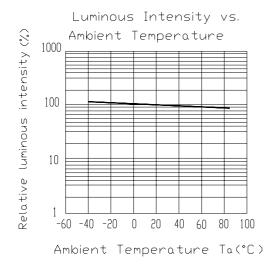


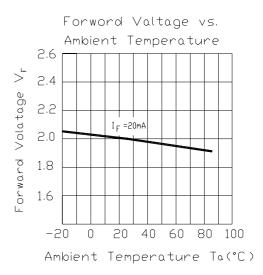
Typical Electro-Optical Characteristics Curves

S2





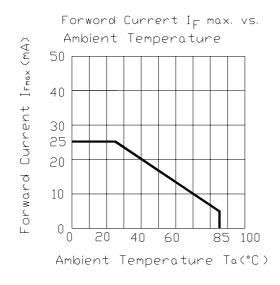


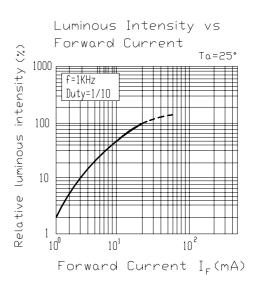


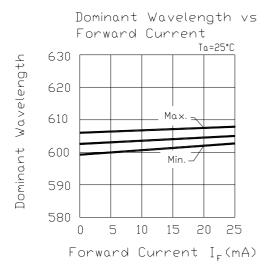


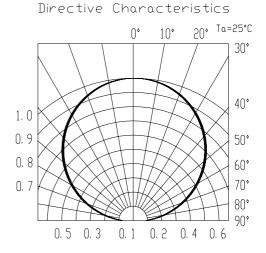
Typical Electro-Optical Characteristics Curves

S2









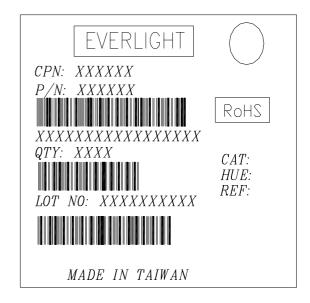


Label explanation

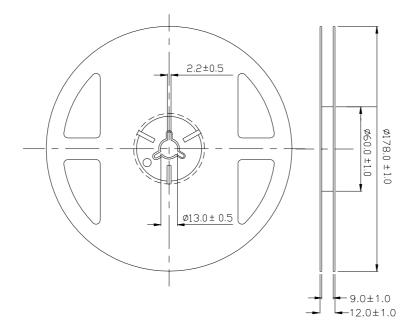
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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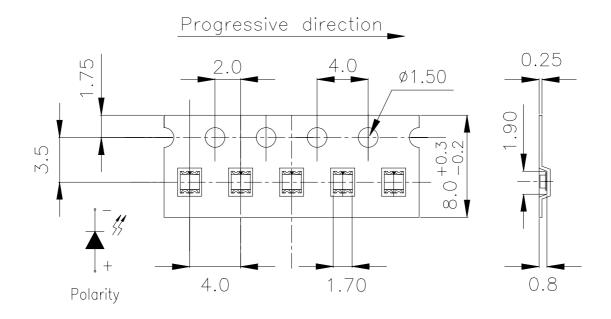
Rev. 4

Page: 9 of 13

Device No:DSE-192-042

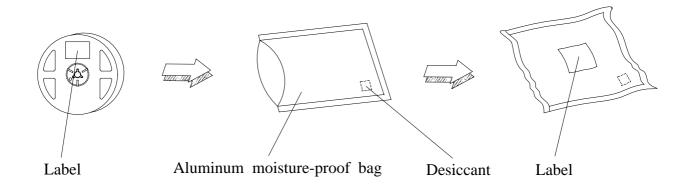
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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



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Moisture Resistant Packaging



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Device No:DSE-192-042

http://www.everlight.com

Prepared date: 25-May-2005

Rev. 4

Page: 10 of 13



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°ℂ	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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Device No:DSE-192-042

http://www.everlight.com

Rev. 4

Page: 11 of 13

Prepared date: 25-May-2005 Prepared by: Jeff Tsai

Precautions For Use

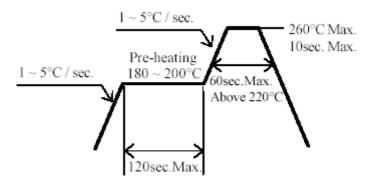
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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Device No:DSE-192-042

http://www.everlight.com

Prepared date: 25-May-2005

Rev. 4

Page: 12 of 13

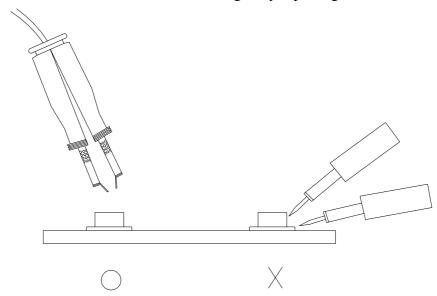


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

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Everlight Electronics Co., Ltd.

Device No:DSE-192-042

http://www.everlight.com

Rev. 4

Page: 13 of 13

Prepared date: 25-May-2005 Pro

单击下面可查看定价,库存,交付和生命周期等信息

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